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Precise control of phase transformation process in lead zirconate titanate thin films by focused line-beam scanning

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Phase transformation and grain growth processes of lead zirconate titanate (PZT) thin films have been precisely controlled by using focused line-beam scanning. The authors promoted the lateral crystallization of PZT grains by controlling a nucleation process and increasing the size of single grains to be as large as 40 \(\mu m\) in length. Focused line-beam scanning allows for the selective growth and crystallization of large PZT grains on predetermined nucleation sites. The high growth rate of the selected PZT grains was attributed to successive suppression of undesirable nucleation except at predetermined positions when pretreated PZT films were exposed to the focused line beam. © 2007 American Institute of Physics. [DOI: 10.1063/1.2719636]

We previously reported the selectively nucleated lateral crystallization (SNLC) of Pb(Zr, Ti)O\textsubscript{3} (PZT) thin films and their electrical characteristics.\textsuperscript{1–3} By SNLC method, we could control the nucleation site, thereby the grain location in PZT thin films. SNLC was based on the selective nucleation and grain growth between the template layer and the perovskite seed. However, the selective growth of the large grains by using the conventional annealing method has a limitation because the annealing temperature should be low enough to prevent undesirable nucleation at unseeded regions, resulting in very low growth rate. Also, even though the annealing temperature is lower than the normal growth temperature of the PZT grains, there is still undesirable nucleation at sites where the pretreated seeds are not present. Therefore, an annealing method, i.e., scanning rapid thermal annealing (RTA), is used in this study to prevent the undesirable nucleation by reducing the processing time. Here, we report the mechanism for SNLC of PZT films and discuss the effect of scan-lamp power and scan speed on their crystallization and microstructure.

PbZr\textsubscript{0.65}Ti\textsubscript{0.35}O\textsubscript{3} thin films were formed on Pt/SiO\textsubscript{2}/Si substrates by rf magnetron sputtering at 350 \(^\circ\)C using multimetal targets of Pb, Zr, and Ti. A base pressure before sputtering was below \(1 \times 10^{-5}\) Torr. The detailed deposition conditions can be found elsewhere.\textsuperscript{1–3} A PZT thin film (100 nm) as the seeding layer was deposited on Pt/SiO\textsubscript{2}/Si substrate and transformed into the perovskite phase by RTA. Seeding islands (area: \(10 \times 10 \mu m^2\), spaces: 40 and 60 \(\mu m\)) were patterned by a conventional lithographic and etching method. A PZT thin film (200 nm) was then deposited on the substrate having PZT seeding islands. The growth behavior of the films was investigated using a Nomarski microscope with differential interference contrast. The microstructure and crystal phases of the PZT films were determined using transmission electron microscopy (TEM) and x-ray diffractometer, respectively.

SNLC annealing was carried out by scanning RTA with tungsten-halogen lamps. A line-shaped light, which was focused with an elliptical reflector, was scanned over the specimen that had been preheated by bottom lamps. The temperature was monitored by a computer-based temperature measurement system connected with a thermocouple located at the side of the specimen. Figure 1 shows the three-dimensional illustration of the scanning-RTA apparatus with the schematic temperature profile and its direction. The local part of the sample was heated at high temperature and the...
were exposed to the temperature profiles in Fig. 2. The pregrowth during the scanning-RTA process. The PZT films crystallized grains, which act as seeds for further grain shown in Fig. 3. The inner circles in Fig. 3 present partially formed after annealing at 680 °C for 1 min. The results are at the prenucleated regions. Figures 3 peak temperature of 660 °C. The grain growth occurred only the scan speed was varied from 0.5 to 1 mm/s with the same heating temperature of the sample was around 500 °C, and increased from about 4 to 20 \( \mu m \). It was noticed that there the growth rate of the line-beam scanning was very fast as compared with that of the conventional furnace annealing (\( \sim \mu m/s \) vs \( \sim \mu m/h \)). The activation energy of the nucleation is generally higher than that of the grain growth.\(^3\) SNLC process exploits this difference in the activation energy between the nucleation and grain growth. It is easily noticed that the higher the energy is, the faster the grain growth is. However, the probability for the nucleation of the PZT grains in the unseeded region is also proportional to the thermal energy. Therefore, the increase in the annealing temperature results in a conflict between the growth rate and the selectivity in SNLC process. If it is possible to apply high energy for a very short period at only desired position with other regions being at low temperature, undesirable nucleation outside the predetermined sites can be minimized. Figure 3(e) shows the SNLC length measured from Figs. 3(a)–3(d) and the integral area of the region above 600 °C in the temperature profiles (Fig. 2) as a function of the scan speed. Both of the SNLC length and the area of the scanned region above 600 °C are inversely proportional to the scan speed. The integral area of temperature profiles is directly related to the heat transferred to the PZT films, which is believed to drive the grain growth.

From the preliminary study using partially grain-grown PZT thin films, the scanning-RTA process was found to be very feasible and effective method to realize SNLC. Thus, the scanning RTA for SNLC was done for the PZT films with etched seeds to align the position of the largely grown grains. The scan speed was 0.5 mm/s whose temperature profile was shown in Fig. 2. Figure 4(a) shows the lateral crystalli-
zation began from the edge of the PZT seeds and ended after making a line grain boundary between seeds (see the arrow). The grown length was about 20 μm. The SNLC with small seeds of 10 × 10 μm² is shown in Fig. 4(b). The square pattern of the single-grained PZT thin films can be clearly seen. Figure 4(c) shows the SNLC of PZT films when the distance between the seeds was as large as 60 μm. The laterally grown length was 25 μm keeping the shape of the seed in view. The crystallization was not completed and the noncrystallized region was shown in lozenge shape. We have measured the electrical properties of PZT thin films selectively crystallized by the scanning-RTA process using the sample shown in Fig. 4(b). The Pt top electrode location was precisely controlled to be aligned inside the grains. The ferroelectric and conduction properties were almost the same as those we previously reported. Thus, by utilizing scanning-RTA process, it is possible to obtain high-quality single-grained PZT thin films with almost complete selectivity in grain growth.

Transmission electron micrograph of the laterally crystallized region in PZT thin films is also presented in the insets of Fig. 4. The micrograph was taken using the sample of Fig. 4(a). It shows almost clean matrix except the small lamellae-type defects. To verify the kinds of line defects, selected area electron diffraction (SAED) analysis was carried out. The corresponding electron diffraction pattern in the other inset of Fig. 4 represents a perovskite single-crystalline pattern viewing along the ⟨111⟩ direction. Macroscopic rhombohedral symmetry can be preserved by averaging in over many small ordered regions with ⟨110⟩ structural modulations. Twin spots were observed along the plane of {101}, indicating that the lamellae-type defects in the laterally crystallized region were twin boundaries. These twins might form during SNLC to reduce the strain energy of the large grains.

PZT thin films with large and position-controlled grains could be obtained by combining the focused line-beam scanning and the seeding method. We show that the grain boundary location in PZT films could be determined by controlling the seed location and the thermal annealing conditions. The thermal profiles could be controlled by changing the scan speed and the lamp power, which directly affected the SNLC process. It was found that scanning RTA was very feasible and to be an effective method for SNLC in reducing the processing time, preventing undesirable nucleation other than the predetermined positions, and in turn increasing the growth rate.

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